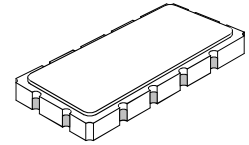


- **Low Insertion Loss**
- **Excellent Selectivity**
- **Hermetic 13.3 X 6.5 mm Surface-mount Case**
- **Single-ended Input and Output**
- **Complies with Directive 2002/95/EC (RoHS)**



PX1004-1

**82.2 MHz
SAW Filter**



SM13365-12

Absolute Maximum Ratings

| Rating | Value | Units |
|--|----------------|-------|
| Maximum Incident Power in Passband | +10 | dBm |
| Maximum DC Voltage Between any 2 Terminals | 30 | VDC |
| Storage Temperature Range | -40 to +85 | °C |
| Suitable for Lead-free Soldering - Maximum Soldering Profile | 260°C for 30 s | |

Electrical Characteristics

| Characteristic | Sym | Notes | Min | Typ | Max | Units | |
|--|---|--------|----------|----------|-----|-------|------------------------|
| Nominal Center Frequency | f_C | | 82.20 | | | MHz | |
| Passband | Insertion Loss at f_C 3 dB Passband | IL | | 3.0 | 5.5 | dB | |
| | | BW_3 | ± 25 | ± 42 | | kHz | |
| | Amplitude Ripple over $f_C \pm 15$ kHz Group Delay Variation over $f_C \pm 17$ kHz | | | | | 1.0 | dB _{P-P} |
| | | GDV | | | | 6.0 | μ s _{P-P} |
| Third-Order Intermod. for -20 dBm tones at $f_C \pm 100$ & 200 kHz | | | | | -95 | dBm | |
| Rejection | $f_C \pm 100$ kHz $f_C - 1500$ kHz to $f_C - 1600$ kHz Ultimate | | 11 | 16 | | dB | |
| | | | 65 | | | | |
| | | | | 65 | | | |
| Operating Temperature Range | T_A | | -20 | | +70 | °C | |

| | |
|---|--|
| Impedance Matching to 50 Ω unbalanced | External L-C |
| Case Style | SM13365-12 13.3 X 6.5 mm Nominal Footprint |
| Lid Symbolization (YY=year, WW=week, S=shift) | RFM PX1004-1 <u>YYWWS</u> |

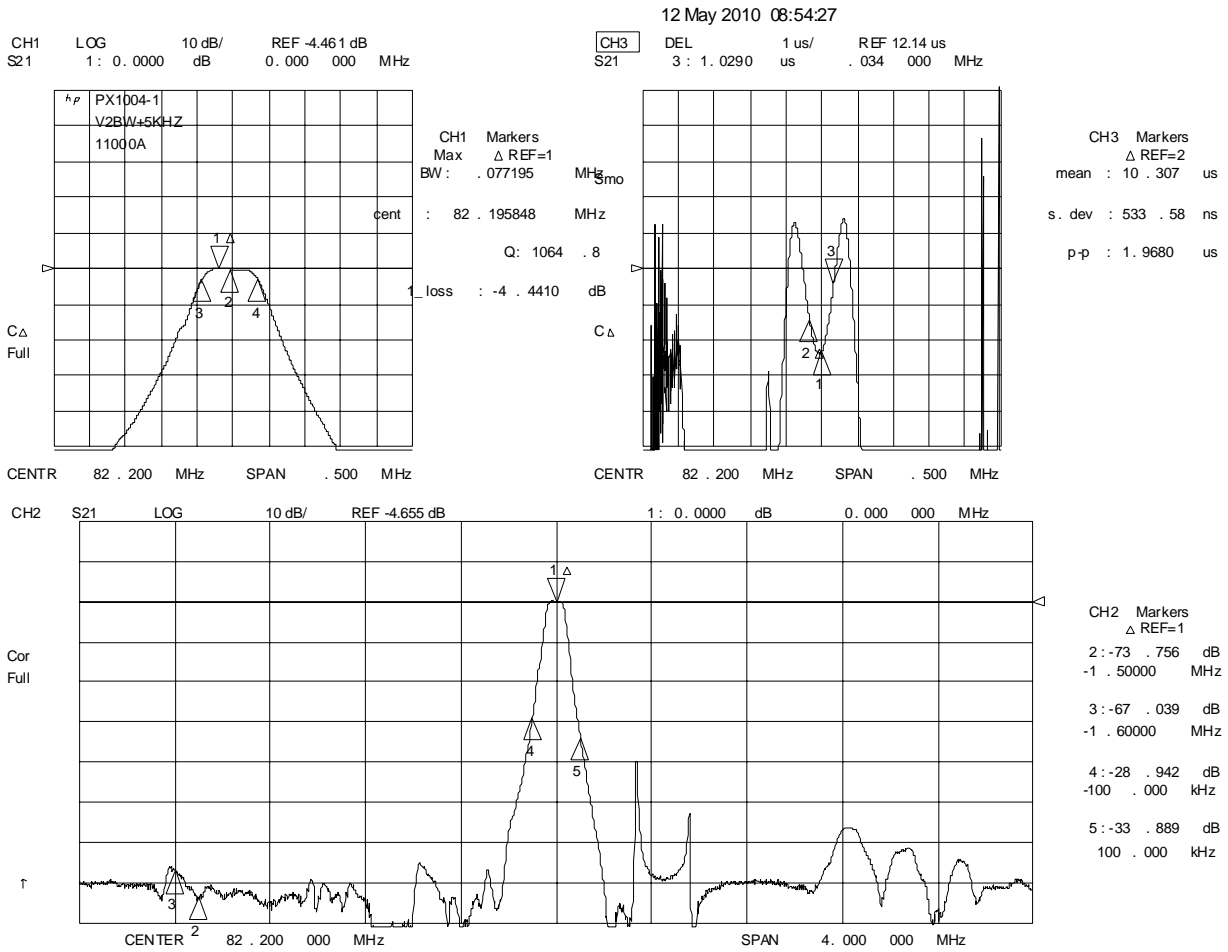


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

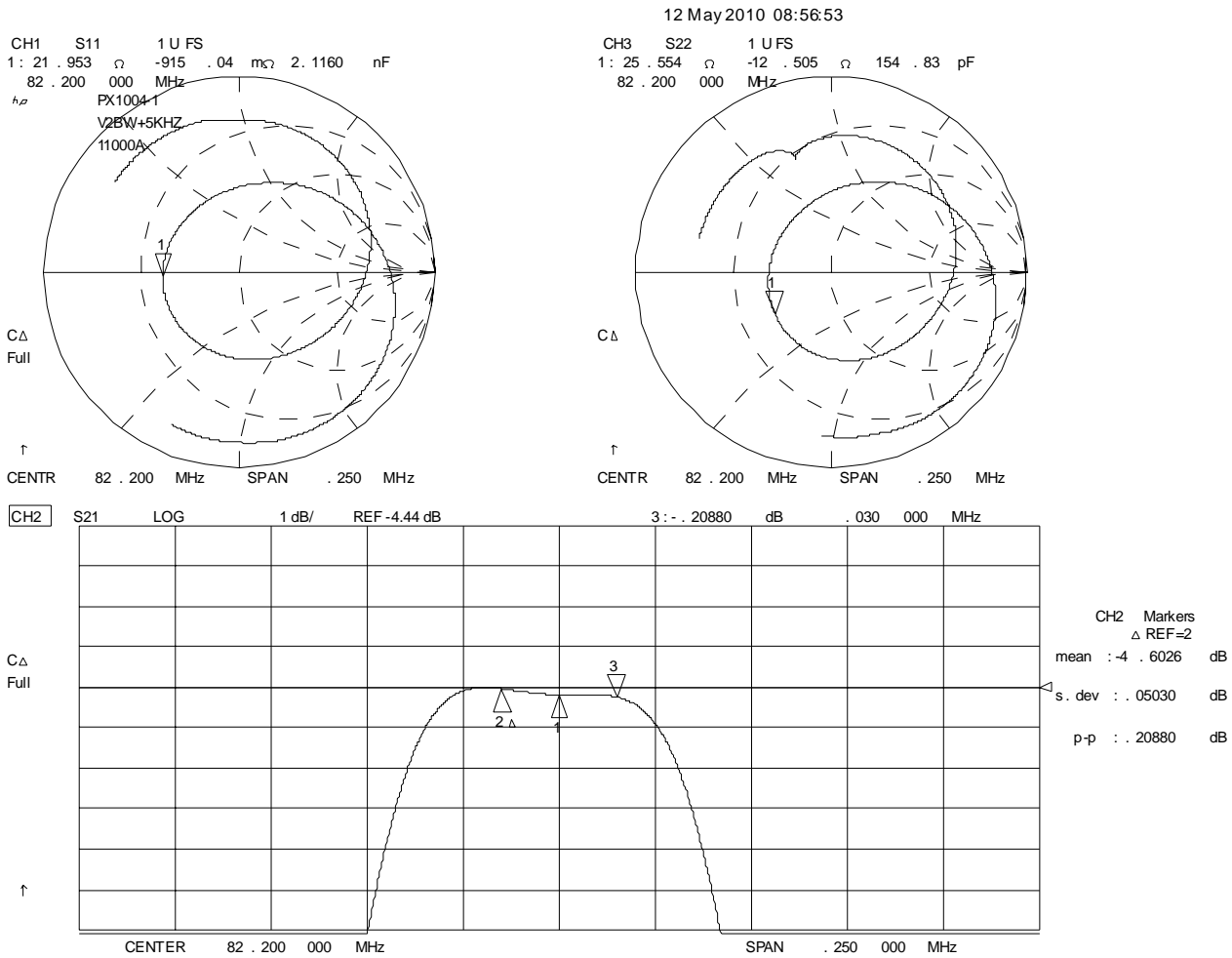
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.

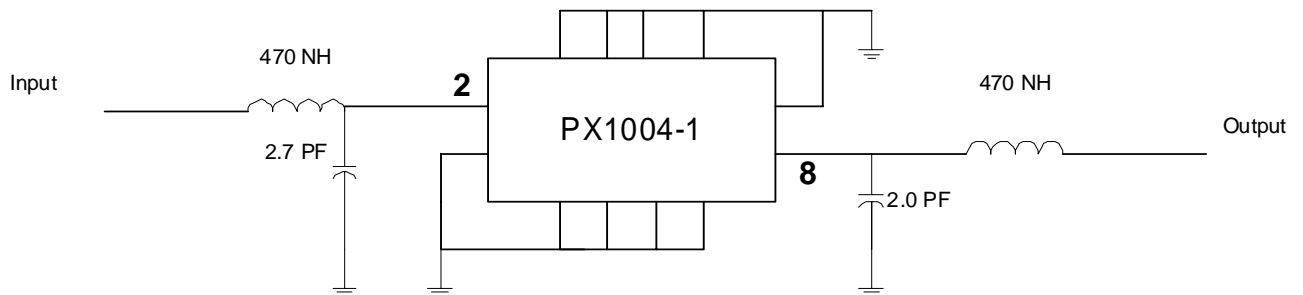
Amplitude and Group Delay Plots



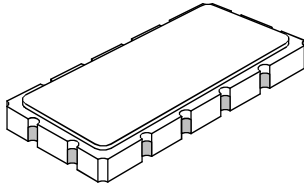
Input/Output Impedance and Passband Amplitude Plots



Filter Test Circuit



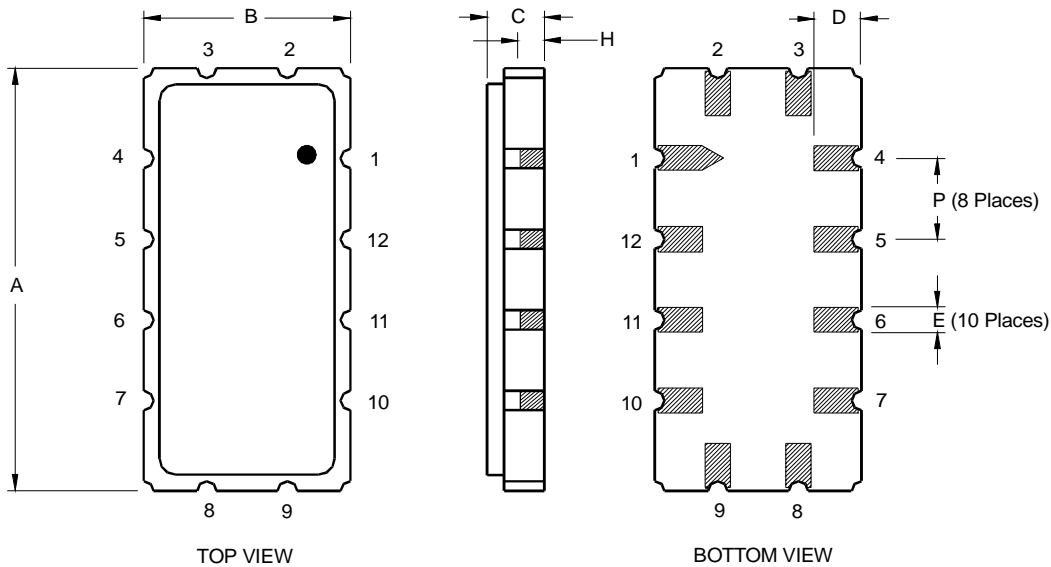
**SM13365-12 Ceramic 12-Terminal Surface-Mount Case
13.3 x 6.5 mm Nominal Footprint**



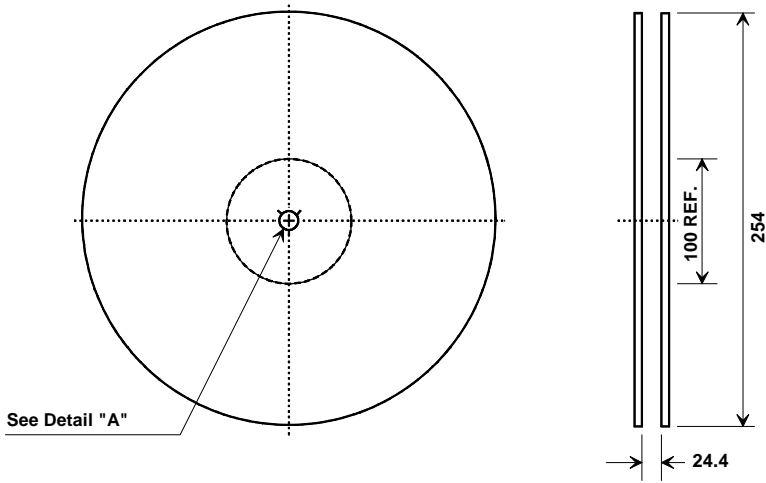
| Case Dimensions | | | | | | |
|-----------------|-------|-------|-------|--------|-------|-------|
| Dimension | mm | | | Inches | | |
| | Min | Nom | Max | Min | Nom | Max |
| A | 13.08 | 13.31 | 13.60 | 0.515 | 0.524 | 0.535 |
| B | 6.27 | 6.50 | 6.80 | 0.247 | 0.256 | 0.268 |
| C | | 1.91 | 2.00 | | 0.075 | 0.079 |
| D | | 1.50 | | | 0.059 | |
| E | | 0.79 | | | 0.031 | |
| H | | 1.0 | | | 0.039 | |
| P | | 2.54 | | | 0.100 | |

| Materials | |
|--------------------|--|
| Solder Pad Plating | 0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel |
| Lid Plating | 2.0 to 3.0 μm Nickel |
| Body | Al_2O_3 Ceramic |
| | Pb Free |

| Electrical Connections | | |
|------------------------|--------|------------------|
| Connection | | Terminals |
| Port 1 | Input | 2 |
| | Return | 3 |
| Port 2 | Output | 8 |
| | Return | 9 |
| | Ground | All others |
| Single-ended Operation | | Return is ground |



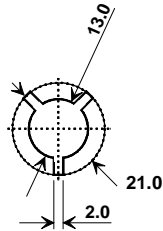
Tape and Reel Specifications



Tape and Reel Standard per ANSI/EIA-481

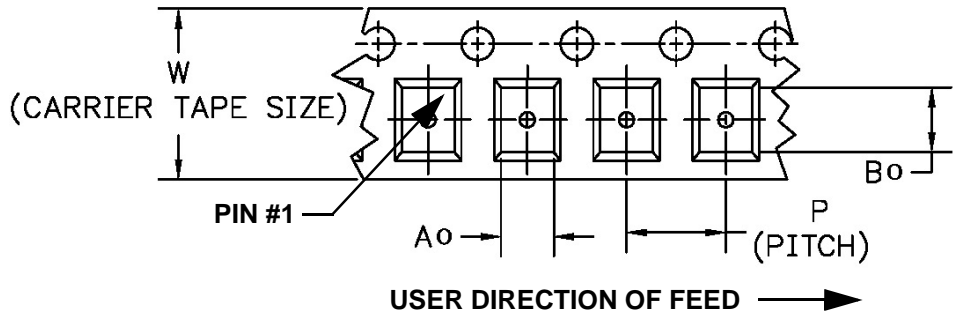
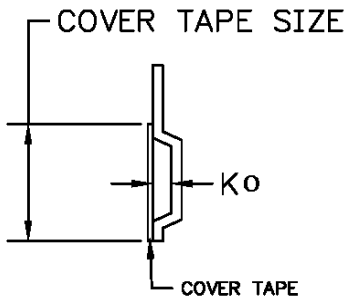
| Quantity Per Reel |
|-------------------|
| 1000 |

See Detail "A"



COMPONENT ORIENTATION and DIMENSIONS

| Carrier Tape Dimensions | |
|-------------------------|---------|
| Ao | 7.0 mm |
| Bo | 13.8 mm |
| Ko | 2.0 mm |
| Pitch | 12.0 mm |
| W | 24.0 mm |



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

